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PATENT

Docket No. JCL-A8191

Date: 2-6-2002

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ASSISTANT COMMISSIONER FOR PATENTS
WASHINGTON, D.C. 20231
ATTENTION: APPLICATION BRANCH

Sir:

Transmitted herewith for filing is the patent application of

Inventors: Chen-Yueh Kung, Kwun-Yao Ho, Jackie Fu

For: METHOD AND STRUCTURE FOR TAPE BALL GRID ARRAY PACKAGE

Enclosed are:

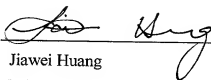
- ☒ Specification 15 pages.
- ☒ 6 Sheets of drawings
- ☒ Recordation Form Cover sheet with 2 pages assignment.
- ☐ A certified copy of Taiwan Patent Application No. dated
- ☒ **SIGNED** declaration and power of attorney.
- ☒ Return Prepaid postcard.



CLAIMS AS FILED

FOR	NUMBER FILED	NUMBER EXTRA	RATE	FEE
Basic Fee			\$740.00	\$740.00
Total Claims	28	20 = 8	\$18.00	\$144.00
Independent Claims	2	3 = 0	\$84.00	\$0.00
If application contains any multiple dependent claim(s), then add			\$280.00	\$0.00
TOTAL FILING FEE				\$884.00

- ☒ A check in the amount of \$884.00 cover the filing fee is enclosed.
- ☒ A check in the amount of \$40.00 to cover the assignment recording fee.
- ☒ A duplicate copy of this sheet is enclosed.


Jiawei Huang

Registration No. 43,330

J.C. PATENTS, INC.
4 VENTURE, SUITE 250
IRVINE, CALIFORNIA 92618
(949) 660-0761
FAX: (949) 660-0809

Assistant Commissioner for Patents
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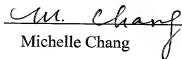
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Docket No. : JCLA8191
Applicant(s) : Chen-Yueh Kung, Kwun-Yao Ho, Jackie Fu
For : METHOD AND STRUCTURE FOR TAPE
BALL GRID ARRAY PACKAGE
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Mailing Label No.
Date of Deposit : February 06, 2002

I hereby certify that the accompanying

Transmittal in Duplicate; Specification 15 pages, 6 sheets of drawings; **SIGNED**
Declaration and Power of Attorney 2 pages; Recordation Form Cover Sheet and
Assignment 3 pages; Checks for Filing Fee(s); Return Prepaid Postcard

are being deposited with the United States Postal Service "Express Mail Post Office to
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Michelle Chang